

FDP027N08B N-Channel PowerTrench[®] MOSFET 80 V, 223 A, 2.7 mΩ

Features

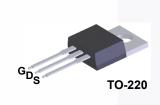
- $R_{DS(on)}$ = 2.21 m Ω (Typ.) @ V_{GS} = 10 V, I_D = 100 A
- Low FOM R_{DS(on)} * Q_G
- Low Reverse-Recovery Charge, Q_{rr} = 112 nC
- Soft Reverse-Recovery Body Diode
- Enables High Efficiency in Synchronous Rectification
- · Fast Switching Speed
- · 100% UIL Tested
- · RoHS Compliant

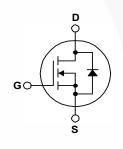
Description

This N-Channel MOSFET is produced using Fairchild Semiconductor's PowerTrench[®] process that has been tailored to minimize the on-state resistance while maintaining superior switching performance.

Applications

- · Synchronous Rectification for ATX / Server / Telecom PSU
- Battery Protection Circuit
- · Motor Drives and Uninterruptible Power Supplies





MOSFET Maximum Ratings T_C = 25°C unless otherwise noted.

Symbol	Parameter		FDP027N08B_F102	Unit	
V _{DSS}	Drain to Source Voltage		80	V	
V _{GSS}	Gate to Source Voltage		±20	V	
I _D Drair		- Continuous (T _C = 25 ^o C, Silicon Limited)	223*	223* 158* A	
	Drain Current	- Continuous (T _C = 100 ^o C, Silicon Limited)	158*		
		- Continuous (T _C = 25 ^o C, Package Limited)	120		
I _{DM}	Drain Current	- Pulsed (Note 1)	892	Α	
E _{AS}	Single Pulsed Avalanche Energy (Note 2)		917	mJ	
dv/dt	Peak Diode Recovery dv/dt (Note 3)		6.0	V/ns	
P _D Po	Power Dissinction	(T _C = 25°C)	246	W	
	Power Dissipation	- Derate Above 25°C	1.64	W/ºC	
T _J , T _{STG}	Operating and Storage Temperature Range		-55 to +175	°C	
TL	Maximum Lead Temperature for Soldering, 1/8" from Case for 5 Seconds		300	°C	

*Calculated continuous current based on maximum allowable junction temperature. Package limitation current is 120 A.

Thermal Characteristics

Symbol	Parameter FDP027N08B_F		Unit	
$R_{ extsf{ heta}JC}$	Thermal Resistance, Junction to Case, Max. 0.61			
$R_{ extsf{ heta}JA}$	Thermal Resistance, Junction to Ambient, Max.	62.5	°C/W	

November 2013

		Package	•		Тар	e Width	Qua	ntity	
		TO-220				N/A	50 units		
Electrica	I Chara	acteristics T_c =	25°C unless	otherwise noted.					
Symbol		Parameter		Test Conditions		Min.	Тур.	Max.	Unit
Off Charac	teristics	1							
BV _{DSS}	1	, Source Breakdown V	oltage	I _D = 250 μA, V _{GS} = 0 V		80	_	_	V
ΔBV _{DSS}		wn Voltage Temperat	0	$I_D = 250 \ \mu\text{A}, \ \text{Referenced to } 25^{\circ}\text{C}$		00			
$/\Delta T_J$	Coefficie	U 1				-	0.05	-	V/°C
				V _{DS} = 64 V, V _{GS} = 0 V		-	-	1	
DSS	Zero Gat	te Voltage Drain Curro	ent	$V_{\rm DS} = 64 \text{ V}, T_{\rm C} = 150^{\circ}\text{C}$		-	-	500	μA
I _{GSS}	Gate to E	Body Leakage Currer	nt	$V_{GS} = \pm 20 \text{ V}, \text{ V}_{DS} = 0$		-	-	±100	nA
On Charac	toriotico							1	
			_	V = V = 250 ···	^	25		4.5	V
V _{GS(th)}		eshold Voltage	iotonoo	$V_{GS} = V_{DS}, I_{D} = 250 \mu$		2.5	-	4.5 2.7	
R _{DS(on)}			sistance	$V_{GS} = 10 \text{ V}, \text{ I}_{D} = 100 \text{ A}$ $V_{DS} = 10 \text{ V}, \text{ I}_{D} = 100 \text{ A}$		-	2.21 227		mΩ S
9 _{FS}		Transconductance		$v_{\rm DS} = 10 v, i_{\rm D} = 100 v$		-	221	-	3
Dynamic C	haracte	ristics							-
C _{iss}	Input Ca	t Capacitance		V _{DS} = 40 V, V _{GS} = 0 V,		-	10170	13530	pF
C _{oss}	Output C	apacitance		f = 1 MHz		-	1670	2220	pF
C _{rss}	Reverse	Transfer Capacitance	e			-	35	-	pF
C _{oss} (er)	Engry Related Output Capacitance		ance	V_{DS} = 40 V, V_{GS} = 0 V		-	3025	-	pF
Q _{g(tot)}	Total Gat	e Charge at 10V				-	137	178	nC
Q _{gs}	Gate to S	Source Gate Charge		V _{DS} = 40 V, V _{GS} = 10 V, I _D = 100A f = 1 MHz		-	56	-	nC
Q _{gs2}	Gate Cha	arge Threshold to Pla	iteau			-	25	-	nC
Q _{gd}	Gate to E	Drain "Miller" Charge				-	28	-	nC
ESR	Equivale	nt Series Resistance	(G-S)			-	2.4	-	Ω
Switching	Charact	eristics							
t _{d(on)}		Delay Time					47	104	ns
t _r	Turn-On	Rise Time		V_{DD} = 40 V, I _D = 100 A, V_{GS} = 10 V, R _G = 4.7 Ω (Note 4)			66	142	ns
t _{d(off)}	Turn-Off	Delay Time				-	87	184	ns
t _f	Turn-Off	Fall Time				7-	41	92	ns
Drain Sour		e Characteristic	e						
				e Forward Current		-	-	223*	А
I _S I	Maximum Continuous Drain to Source Dio							892	
I _{SM}	Maximum Pulsed Drain to Source Diode Fo					-	-		A V
V _{SD}			u voltage	$V_{GS} = 0 V, I_{SD} = 100 A$		-	- 80	1.3	
t _{rr}		Recovery Time		$V_{GS} = 0 V, V_{DD} = 40 V$	/, I _{SD} = 100 A,	-	80	-	ns
Q _{rr}	Reverse Recovery Charge $dI_F/dt = 100 A/\mu s$			-	112	-	nC		

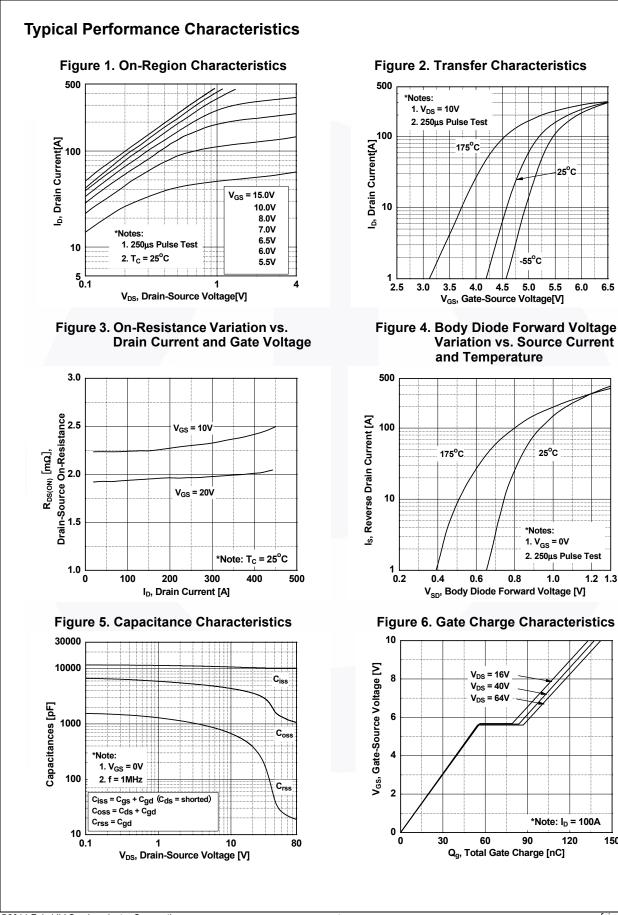
 $\begin{array}{l} \text{2. L}=3 \text{ mH}, \text{ I}_{AS}=24.72 \text{ A}, \text{ R}_{G}=25 \ \Omega, \text{ starting } \text{T}_{J}=25^{\circ}\text{C}. \\ \text{3. I}_{SD}\leq100 \text{ A}, \text{ di/dt}\leq200 \text{ A/}\mu\text{s}, \text{ V}_{DD}\leq\text{BV}_{DSS}, \text{ starting } \text{T}_{J}=25^{\circ}\text{C}. \end{array}$

Essentially independent of operating temperature typical characteristics.

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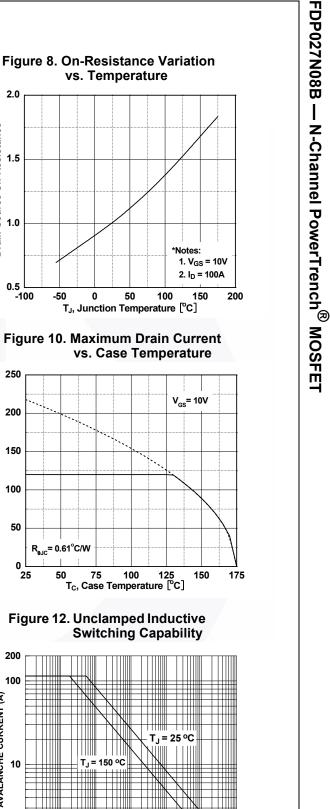
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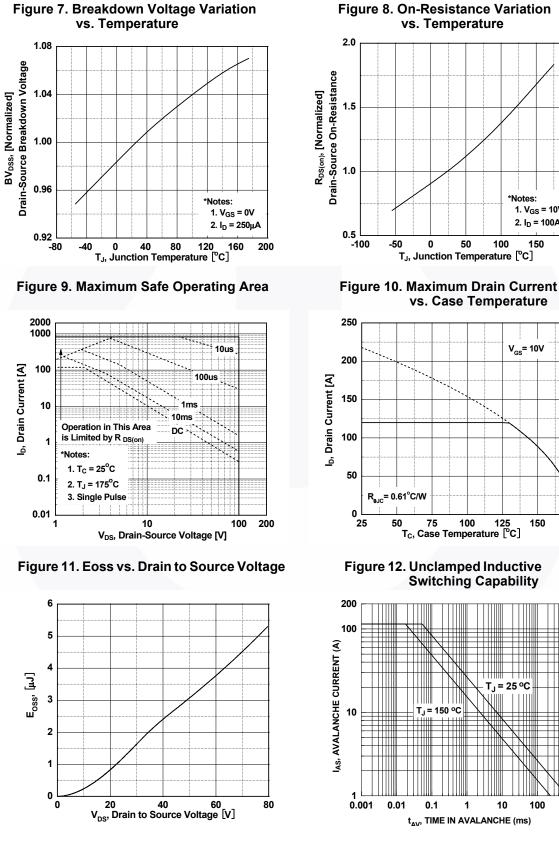


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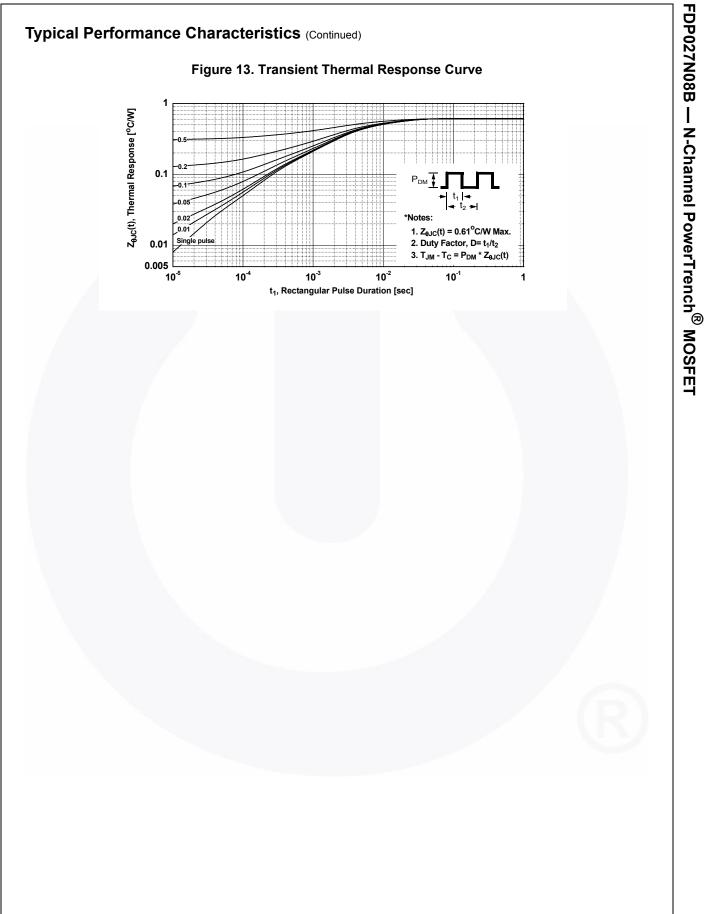
Typical Performance Characteristics (Continued)

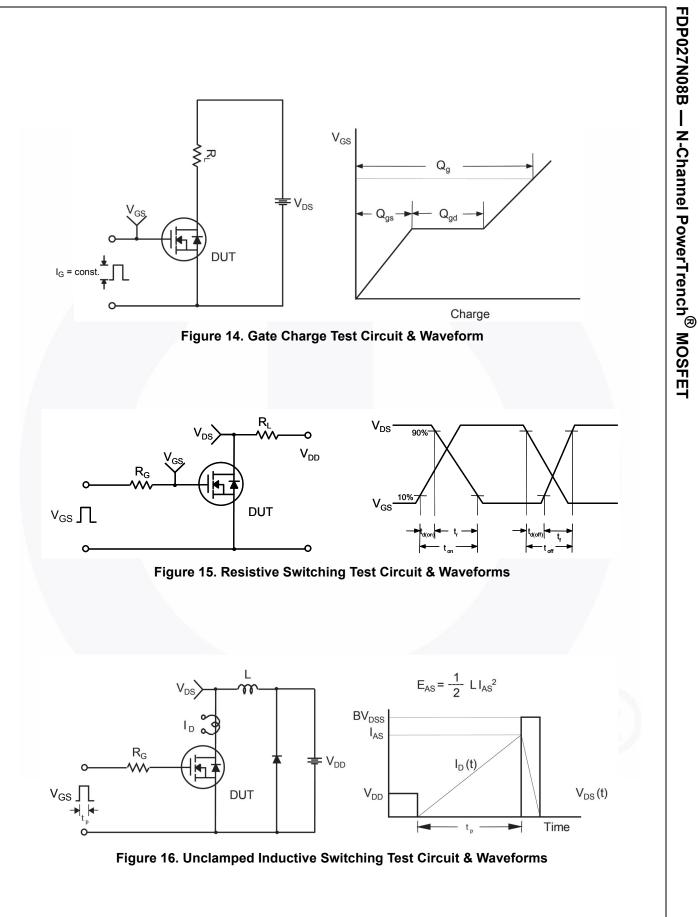
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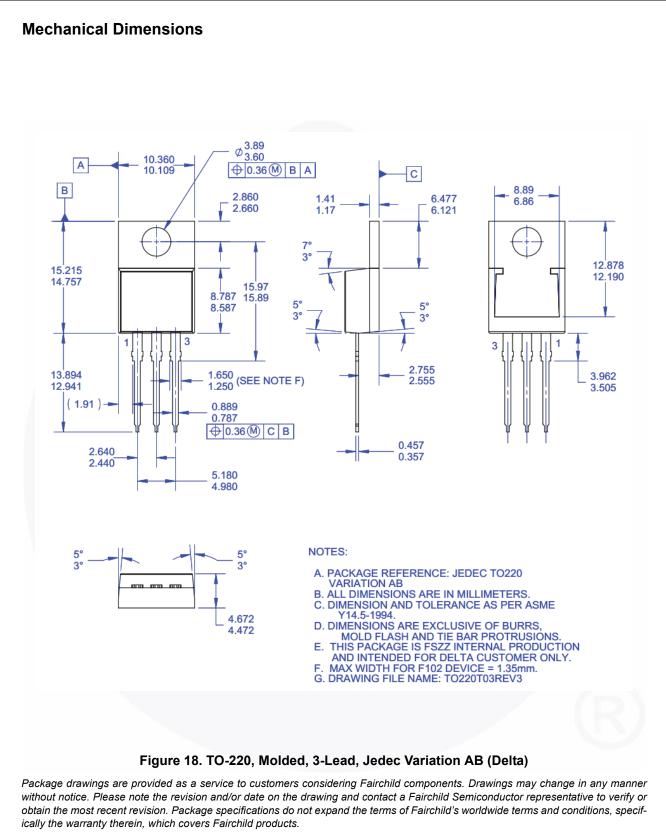
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DUT + v_{DS} a ۱_{SD} م L Driver R_G, Same Type as DUT L F ∨_{DD} $\prod V_{GS}$ • dv/dt controlled by R_{G} • I_{SD} controlled by pulse period Î Gate Pulse Width V_{GS} D = Gate Pulse Period 10V (Driver) I_{FM}, Body Diode Forward Current I _{SD} di/dt (DUT) I_{RM} Body Diode Reverse Current V_{DS} (DUT) Body Diode Recovery dv/dt V_{SD} V_{PD} Body Diode Forward Voltage Drop Figure 17. Peak Diode Recovery dv/dt Test Circuit & Waveforms

7



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